



FDP5690/FDB5690

60V N-Channel PowerTrench™ MOSFET

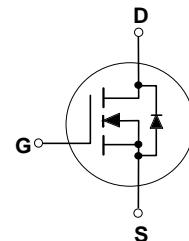
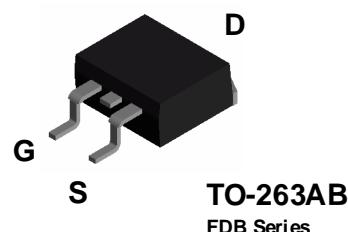
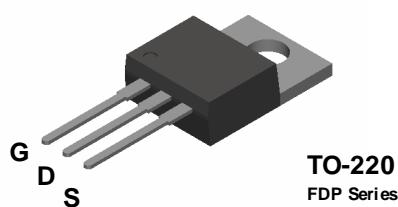
General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{DS(on)}$ specifications resulting in DC/DC power supply designs with higher overall efficiency.

Features

- 32 A, 60 V. $R_{DS(ON)} = 0.027 \Omega @ V_{GS} = 10 \text{ V}$
 $R_{DS(ON)} = 0.032 \Omega @ V_{GS} = 6 \text{ V}$.
- Critical DC electrical parameters specified at elevated temperature.
- Rugged internal source-drain diode can eliminate the need for an external Zener diode transient suppressor.
- High performance trench technology for extremely low $R_{DS(ON)}$.
- 175°C maximum junction temperature rating.



Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	FDP5690	FDB5690	Units
V_{DSS}	Drain-Source Voltage	60		V
V_{GSS}	Gate-Source Voltage		± 20	V
I_D	Maximum Drain Current - Continuous	32	A	
	- Pulsed	100		
P_D	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	58	W	
	Derate above 25°C	0.4		W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-65 to +175		$^\circ\text{C}$

Thermal Characteristics

R_{JJC}	Thermal Resistance, Junction-to-Case	2.6	$^\circ\text{C/W}$
R_{JJA}	Thermal Resistance, Junction-to-Ambient	62.5	$^\circ\text{C/W}$

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDB5690	FDB5690	13"	24mm	800
FDP5690	FDP5690	Tube	N/A	45

Electrical Characteristics $T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Tvp	Max	Units
Drain-Source Avalanche Ratings (Note1)						
W_{DSS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 30 \text{ V}$, $I_D = 32 \text{ A}$			80	mJ
I_{AR}	Maximum Drain-Source Avalanche Current				32	A
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	60			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C		61		mV/ $^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}$, $V_{GS} = 0 \text{ V}$			1	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}$, $V_{DS} = 0 \text{ V}$			100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}$, $V_{DS} = 0 \text{ V}$			-100	nA
On Characteristics (Note 1)						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	2	2.4	4	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C		-6.4		mV/ $^\circ\text{C}$
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$, $I_D = 16 \text{ A}$, $V_{GS} = 10 \text{ V}$, $I_D = 16 \text{ A}$, $T_J = 125^\circ\text{C}$ $V_{GS} = 6 \text{ V}$, $I_D = 15 \text{ A}$	0.021 0.042 0.024	0.027 0.055 0.032		Ω
$I_{D(on)}$	On-State Drain Current	$V_{GS} = 10 \text{ V}$, $V_{DS} = 5 \text{ V}$	50			A
g_F	Forward Transconductance	$V_{DS} = 5 \text{ V}$, $I_D = 16 \text{ A}$		32		S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$		1120		pF
C_{oss}	Output Capacitance			160		pF
C_{rss}	Reverse Transfer Capacitance			80		pF
Switching Characteristics (Note 1)						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 30 \text{ V}$, $I_D = 1 \text{ A}$, $V_{GS} = 10 \text{ V}$, $R_{GEN} = 6 \Omega$		10	18	ns
t_r	Turn-On Rise Time			9	18	ns
$t_{d(off)}$	Turn-Off Delay Time			24	39	ns
t_f	Turn-Off Fall Time			10	18	ns
Q_g	Total Gate Charge	$V_{DS} = 15 \text{ V}$, $I_D = 16 \text{ A}$, $V_{GS} = 10 \text{ V}$		23	33	nC
Q_{gs}	Gate-Source Charge			3.9		nC
Q_{gd}	Gate-Drain Charge			6.8		nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current	(Note 1)			32	A
V_{SD}	Drain-Source Diode Forward Voltage		$V_{GS} = 0 \text{ V}$, $I_S = 16 \text{ A}$	(Note 1)	0.92	1.2

Note:

- Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$

Typical Characteristics

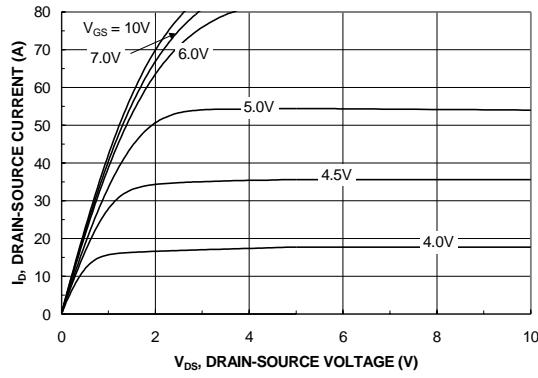


Figure 1. On-Region Characteristics.

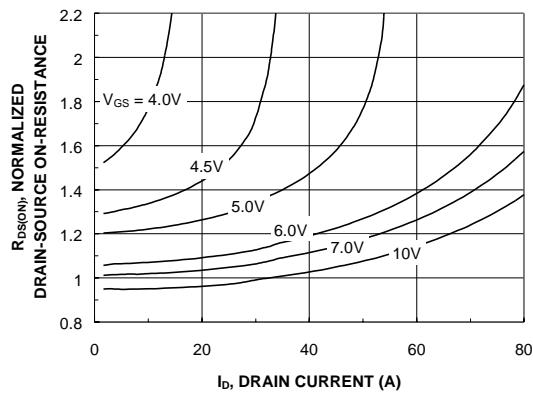


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

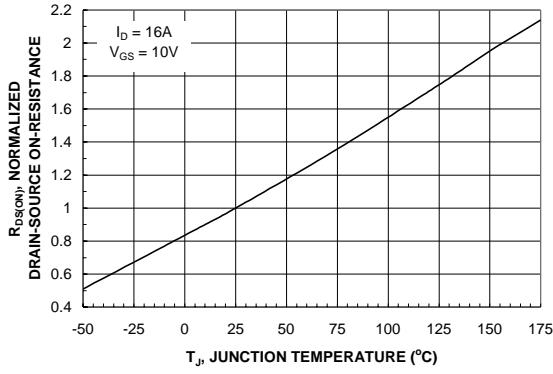


Figure 3. On-Resistance Variation with Temperature.

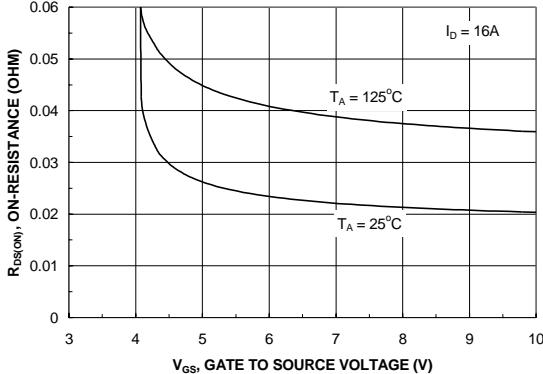


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

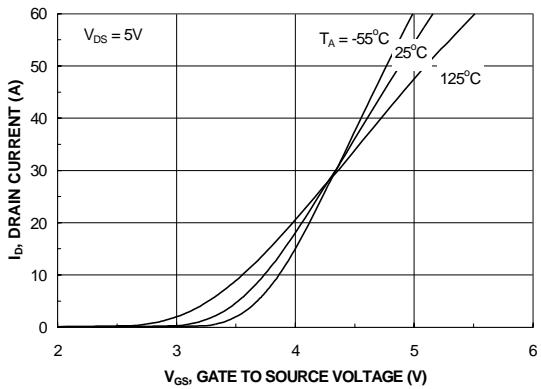


Figure 5. Transfer Characteristics.

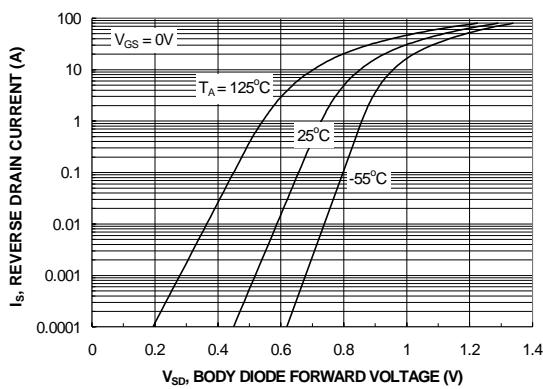


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.